SPECIFICATION FOR CERAMIC CHIP TYPE RESONATOR

TYPE: ZTTCC3.58MHZ

1 Scope

This specification shall cover the characteristics of the ceramic resonator (Chip type) 3.58MHZ for clock oscillation circuit of such as microprocessors.

2. Model Name

2-1 Model Name: ZTTCC 3.58MG

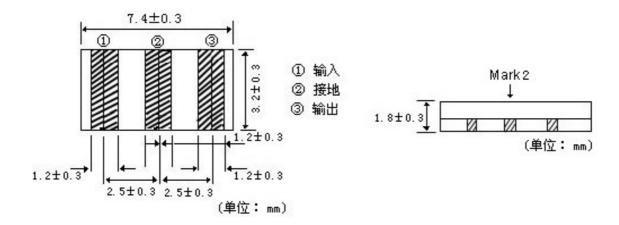
2-2 Specification No:

2-3 Customer's Part Number :2-4 Customer's drawing Number:

3 Outline Drawing and Dimensions

3-1 Appearance: No visible damage and dirt

3-2 Dimensions:



4 Ratings and Characteristics

	Item	Requirements
4-1	Nominal Oscillating Frequency	3.58MHZ
4-2	Initial Tolerance	\pm 0.50%max
4-3	Resonant Resistance	30 Ω max
4-4	Insulation Resistance	$5\times10^8 \ \Omega \min(Applied D.C.10V)$
4-5	Withstanding Voltage	D.C.100V 5 seconds max.
4-6	Rating Voltage (1). D.C. Voltage (2). A.C. Voltage	D.C.6V 15 Vp-p.
4-7	Temperature Stability (-20°C to +80°C) Operating Temperature Storage Temperature	$\pm 0.30\%$ max. (from initial value) $-20^{\circ}\!$
4-8	Aging (for 10 years)	\pm 0.30%max. (from initial value)

5. Physical Characteristics

	Test Item	Condition of Test	Performance Requirements
5-	Random Drop	Resonator shall be measured after 3	No visible damage and the
1	times random drops from the height of		measured values shall meet
		1.0m on concrete floor.	Table 1.
5-	Vibration	Resonator shall be measured after	The measured values shall
2		being applied vibration of amplitude of	meet Table 1.
		1.5mm with 10 to 55HZ band of	
		vibration frequency to each of 3	
		perpendicular directions for 1 hours.	
5-	Resistance to	Lead terminals are immersed up to	The measured values shall
3	soldering Heat	1.5mm from resonator's body in solder	meet Table 1.
		bath of $260 \pm 5 ^{\circ}\!$	
		and then resonator shall be measured	
		after being placed in natural condition	
		for 1 hour.	
5-	Solderability	Lead terminals are immersed in resin	95% min. lead terminals
4		for 5 seconds and then immersed in	shall be wet with solder.
		soldering bath of $230 \pm 5 ^{\circ}{}$ for 3 ± 0.5	
		seconds.	
5-	Terminal	After force 10 seconds of 1.0Kg is	No visible damage and the
5	Strength	applied to each terminal in axial	measured values shall meet
		direction, resonator shall be measured.	Table 1.
			No cutting off.

6 Environmental Characteristics

	Test Item	Condition of Test	Performance Requirements
6-1	High Temperature	After being placed in a chamber with $85\pm2^{\circ}{}$ for 96 ± 4 hours and then being placed in natural condition for 1 hour. Resonator shall be measured.	The measured values shall meet Table 1.
6-2	Low Temperature	After being placed in a chamber with $-30\pm2^{\circ}\mathrm{C}$ for 96 ± 4 hours and then being placed in natural condition for 1 hour. Resonator shall be measured	The measured values shall meet Table 1.
6-3	Humidity	After being placed in a chamber with 90 to 95% R.H. at $+60\pm2^{\circ}$ for $96\pm$ 4 hours and then being placed in natural condition for 1 hour. Resonator shall be measured	The measured values shall meet Table 1.
6-4	Heat Shock	After being kept at room temperature, resonator shall be placed at temperature of −30°C, After 30 minutes at this temperature, resonator shall be immediately placed at temperature of +85°C. After 30 minutes at this temperature, resonator shall be returned to -30°C again, after 5 above cycles, resonator shall be returned to room temperature. And resonator shall be measured after being placed in natural condition for 1 hour.	The measured values shall meet Table 1.

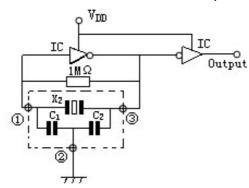
Table 1

Measurements	Requirements
Oscillating Frequency	$\pm 0.3\%$ max. (from initial value)
Resonant Resistance	Δ R1<5Ω

7 Test Circuit

- 7-1 Oscillating Frequency: Please note that the T series oscillates stably even if terminal (1) and (3) is connected reversibly, but it may cause a little frequency lag.
- 7-2 Equivalent Circuit Constants: Network Analyzer Hp87510A or Equivalent.
 - 7-3 measuring condition: Temperature $+25\pm3^{\circ}$ C

Humidity 60 to 10% R.H

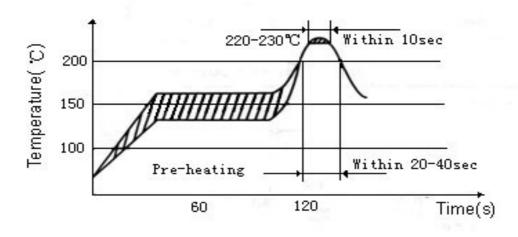


VDD=+5V

C1=C2=30PF

IC: 1/6CD4069UBE(RCA) X 2

8 Recommended re-flow soldering standard conditions



Notice:

- 1. In case of immersing in cleaning solvent, the temperature of component must be returned to room temperature after soldering
- 2. Please insure the component is thoroughly evaluated in your application circuit